

■ Lead Forming

• In order to facilitate insertion into printed circuit board, lead wires are cut or formed.

Product Size Table Unit: mm

						Unit: mr				
Forming name	Dimension			Lead	Forming&	Outling describes				
	F (Lead pitch)	φD (Case diameter)	Style	forming symbol	packing code*	Outline drawing				
		10	Α	F	A00					
Forming cut	5.0	12.5	Α	F	A01					
	7.5	16 to 18	Α	F	A01	Processed style A				
						4.5±0.5				
Snap-in										
	5.0	10	A	S1	202	Processed style A				
	7.5	12.5 16 to 18	A A	S1 S1	203					
	7.5	10 10 18	А	31	S1 203					
						4.5±0.5				
Forming cut (restrict series)	7.5	10 12.5 10 12.5 10 16 to 18		F49 F49 F51 F51 F58 F49 F51	AOA AOB AOE AOF AOU AOB AOF	F49 3.2±0.5 F51 3.1 ^{+0.4}				

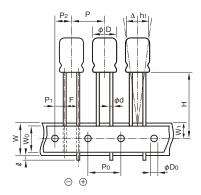
Forming name	Dimension				Lead	Forming&			
	F (Lead pitch)	φD (Case diameter)	lо	l 1	forming symbol	packing code*	Outline drawing		
For 90° side mount of case	5.0	10	5.5	1.0	G9, G10	M16, M18			
		12.5	5.5	1.0	G9, G10	M17, M19			
		12.5	7.5	2.5	G55, G56	MOK, MOM			
		10	3.6	1.0	G59, G60	MOS, MOU	\$\frac{1}{2}\frac{1}{2		
		12.5	3.6	1.0	G59, G60	MOT, MOV			
		12.5	0.96	4.9	G95, G96	M4B, M4D			
		10	1.0	1.9	G99, GA0	M4J, M4L			
		10	4.5	1.0	GAS, GAT	M7A, M7C			
		12.5	4.5	1.0	GAS, GAT	M7B, M7C			
	7.5	16 to 18	5.5	1.0	G9, G10	M17, M19	F±0.5		
		16 to 18	4.5	1.0	GAS, GAT	M7B, M7D	\ominus \oplus \ominus		
				G9, G55, G59, G10, G56, G60,					
							G95, G99, GAS G96, GA0, GAT		

*Forming and packing code: Packing is standard packing. Please refer to "PACKING" page. Other lead forming and optional packing code: please contact us.





• For automatic insertion (radial lead type)



^{*}The shape of a lead wire sandwiched by the mounting strips may differ from the ones shown in the figures.

Product Size Table Unit: mm

Item	Symbol	Tolerance	11L to 25L		
iteiii	Symbol	Tolerance	φ10	φ12.5	
Lead forming symbol (Taping packing coed)	_	_	T2 (100)	T4 (101)	
Lead-wire diameter	φd	±0.05	0.6		
Lead to lead distance	F	+0.8 -0.2	5.0		
Height of component from tape center	Н	+0.75 -0.5	18.5		
Pitch of component	Р	±1.0	12.7	15.0	
Feed hole pitch	Po	±0.3	12.7	15.0	
Hole center to lead	P ₁	±0.7	3.85	5.0	
Hole center to component	P ₂	±1.0	6.35	7.5	
Tape width	W	±0.5	18.0		
Hold down tape width	Wo	Min.	6.0		
Feed hole position	W1	±0.5	9.0		
Max. lead protrusion	l	Max.	1.0		
Feed hole diameter	φDo	±0.2	4.0		
Alignment of component to center	Δh	±1.0	0		
Alignment of component to center	Δh1	±1.0	0		
Total tape thickness	t	±0.2	0.7		

Please contact us for lead forming and packing code in regards to the product code.